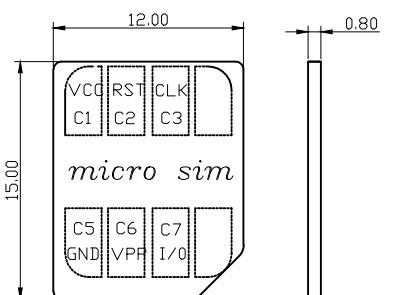
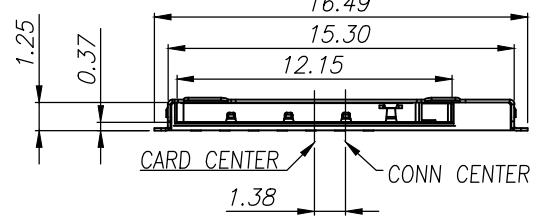
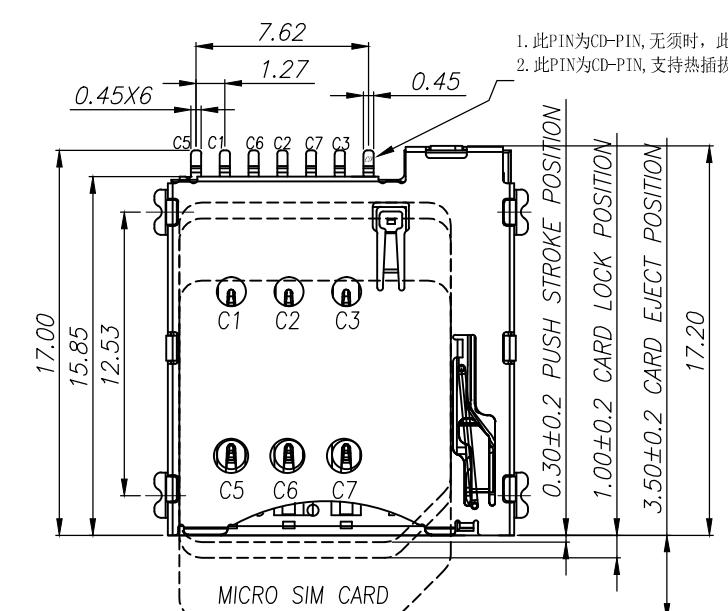
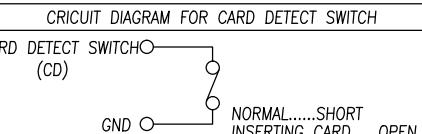


REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2012/10/29



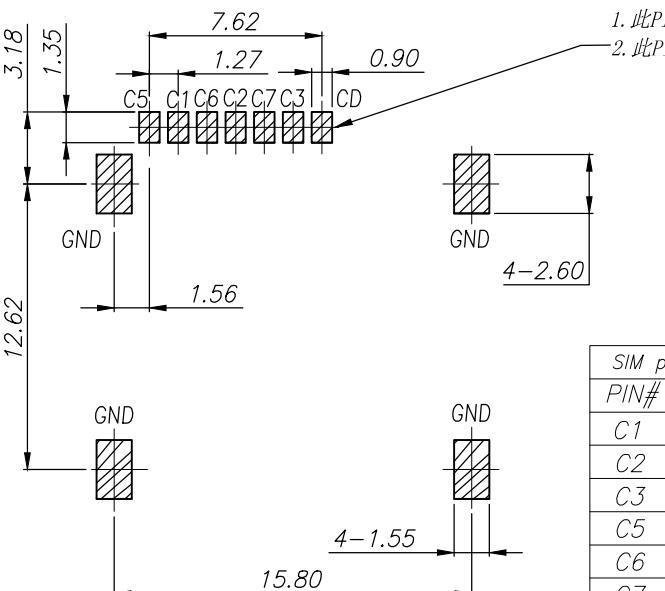
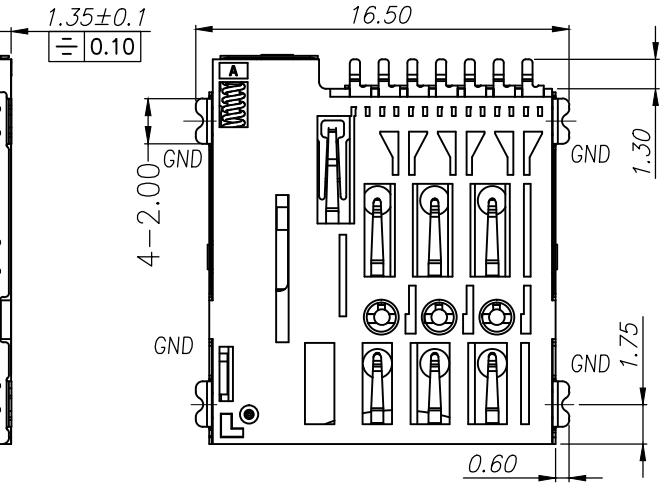
MICRO SIM CARD



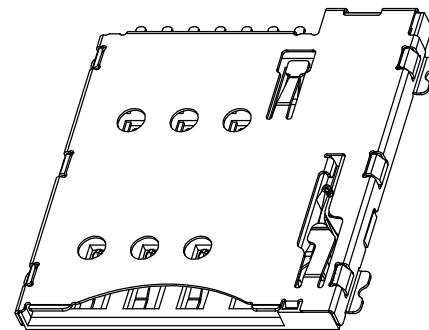
CIRCUIT TRACE KEEP OUT AREA
SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES
IN THE LAYOUT SPACE OF THE PRODUCTS.

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



1. 此PIN为CD-PIN,此PIN无须时不需要设计PCB焊盘。
2. 此PIN为CD-PIN,支持热插拔,有须要可设计此功能。

NOTES:

MATERIAL:

Insulator: High Temperature Thermoplastic,UL 94V-0.
Contact: Copper Alloy
Shell: STAINLESS

PLATING:

Contact: Plated 30μ Ni Overall Contact Au 1U
Shell: Plated 30μ Ni Overall
Plated 1u Au Selective Contact Area

Electrical:

Current Rating : 0.5mA AC/DC max.
Voltage Rating : 125V AC/DC
Ambient Temperature Range :-20° C +60° C
Storage Temperature Range :-40° C +70° C
Ambient Humidity Range : 95% R.H. Max.
Contact Resistance: 100mΩ max.
Insulation Resistance: 1000MΩ min./500VDC
Mating Cycles: 5,000 Insertions
Temperature: 260° C ±5°

GENERAL TOLERANCE	DWG NO.	APPD:	WIND	Scale	1:1
X.±0.45	Title	1.35H 7PIN PUSH MICRO SIM CARD CONNECTOR	CHKD:	UNIT	mm
.X±0.35					
.XX±0.25	Part NO.	5001B-SIM135-096	DR:		
.XXX±0.15			Date	2012/10/29	
SHEET	1/1				

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